# 7-1658012-1 ACTIVE

#### **MICTOR**

TE Internal #: 7-1658012-1

PCB Mount Receptacle, Vertical, Board-to-Board, 28 Position, .8 mm [.031 in] Centerline, Fully Shrouded, Gold, Surface Mount,

Power & Signal, Black

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 28

Centerline (Pitch): .8 mm [ .031 in ]

#### **Features**

#### **Product Type Features**

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

### **Configuration Features**

Stackable	No
Connector Contact Load Condition	Differential Load
PCB Mount Orientation	Vertical
Number of Positions	28
Board-to-Board Configuration	Parallel

#### **Electrical Characteristics**

Dielectric Withstanding Voltage (Max)	675 VAC
Insulation Resistance	2 ΜΩ
Impedance	100 Ω
Operating Voltage	125 VAC

### **Body Features**

Assembly Process Feature Material	Polyimide Film	
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Primary Product Color	Black
Contact Features	
PCB Contact Termination Area Plating Material Thickness	.25 μm[9.8425 μin]
Mating Tab Width	.38 mm[.015 in]
Mating Tab Thickness	.2 mm[.008 in]
Contact Shape & Form	Single Beam
PCB Contact Termination Area Plating Material	Gold
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.25 μm[9.8425 μin]
Contact Type	Socket
Contact Current Rating (Max)	1.25 A, 9.5 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.15 mm[.006 in]
Rectangular Termination Post & Tail Width	1.77 mm[.07 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
Mating Retention	With
Mating Alignment	Without
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.8 mm[.031 in]
Housing Material	LCP (Liquid Crystal Polymer)
Dimensions	
Connector Height	3.05 mm[.12 in]
Stack Height	5 mm, 8 mm, 11 mm, 16 mm, 19 mm, 22 mm, 25 mm, 30 mm[1.181 in]
PCB Thickness (Recommended)	.06 mm[.25 in]
Usage Conditions	



Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Assembly Process Feature	Pick and Place Cover
Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	475
Packaging Method	Pocket Tape

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**













# Customers Also Bought





SW PIR HDR BP, 92OHM, 4X4 OEW



68POS

TE Part #2373760-2 SAS/PCIE (U.2/U.3) RECEPTACLE, 68POS

TE Part #2187690-1 SW PIR HDR BP, 92OHM, 6X6 OE

TE Part #2302428-1 SFP+ 1x6 Cage Assembly TE Part #2325259-1 RA REC ASSY 4X6, 92OHM PIR WHISPER R TE Part #2327671-8
RECEPT ASSY, RA, 84 POS, SLIVER 2.0

TE Part #2159921-1 M-SAS 4X, 6GBPS, 5.0M

### **Documents**



### **Product Drawings**

MSB0.80RC-ASY28DP,GP,10,VCTR

English

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_7-1658012-1\_P.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_7-1658012-1\_P.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_7-1658012-1\_P.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### **Product Specifications**

**Application Specification** 

English